

## STD25NF10LA

# N-channel 100 V, 0.030 Ω 25 A DPAK STripFET™ II Power MOSFET

#### **Features**

Order code	V <sub>DSS</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub>
STD25NF10LA	100 V	< 0.035 Ω	25 A

- Exceptional dv/dt capability
- 100% avalanche tested
- Logic level device

#### **Applications**

- Switching application
- Automotive



This Power MOSFET has been developed using STMicroelectronics' unique STripFET process, which is specifically designed to minimize input capacitance and gate charge. This renders the device suitable for use as primary switch in advanced high-efficiency isolated DC-DC converters for telecom and computer applications, and applications with low gate charge driving requirements.

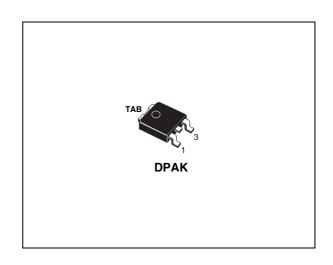


Figure 1. Internal schematic diagram

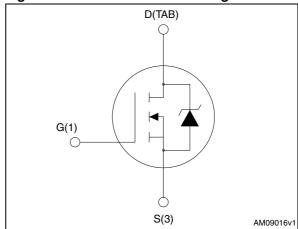


Table 1. Device summary

Order code	Marking	Package	Packaging
STD25NF10LA	STD25NF10LA D25NF10LA		Tape and reel

Contents STD25NF10LA

## **Contents**

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STD25NF10LA Electrical ratings

## 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
$V_{DS}$	Drain-source voltage	100	V
V <sub>GS</sub>	Gate- source voltage	± 16	V
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25 °C	25	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	21	Α
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	100	Α
P <sub>tot</sub>	Total dissipation at T <sub>C</sub> = 25 °C	100	W
	Derating Factor	0.67	W/°C
dv/dt <sup>(3)</sup>	Peak diode recovery avalanche energy	20	V/ns
E <sub>AS</sub> (4)	Single pulse avalanche energy	450	mJ
T <sub>stg</sub>	Storage temperature -55 to 175		°C
Tj	Max. operating junction temperature	-55 10 175	

<sup>1.</sup> Current limited by package

Table 3. Thermal data

Symbol	Parameter	Value	Unit
Rthj-case	Thermal resistance junction-case max	1.5	°C/W
Rthj-pcb	Thermal resistance junction-pcb max (1)	50	°C/W

<sup>1.</sup> When Mounted on 1 inch2 FR-4 board, 2 oz. of Cu.

<sup>2.</sup> Pulse width limited by safe operating area.

<sup>3.</sup>  $I_{SD} \leq 25 \text{ A}$ , di/dt  $\leq 300 \text{ A/}\mu\text{s}$ ,  $V_{DD} = V_{(BR)DSS}$ ,  $T_J \leq T_{JMAX}$ 

<sup>4.</sup> Starting  $T_j = 25$  °C,  $I_D = 12.5$  A  $V_{DD} = 50$  V

Electrical characteristics STD25NF10LA

## 2 Electrical characteristics

 $(T_{CASE}=25^{\circ}C \text{ unless otherwise specified})$ 

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0$	100			V
I <sub>DSS</sub>	Zero gate voltage drain current	V <sub>DS</sub> = 100 V V <sub>DS</sub> = 100 V, T <sub>C</sub> = 125 °C V <sub>GS</sub> =0			1 10	μ <b>Α</b> μ <b>Α</b>
I <sub>GSS</sub>	Gate-body leakage current	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1		2.5	V
R <sub>DS(on)</sub>	Static drain-source on resistance	$V_{GS} = 10 \text{ V}, I_D = 12.5 \text{ A}$ $V_{GS} = 4.5 \text{ V}, I_D = 12.5 \text{ A}$		0.030 0.035	0.035 0.040	Ω Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 25 \text{ V, f} = 1 \text{ MHz,}$ $V_{GS} = 0$	-	1710 250 110		pF pF pF
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Turn-on delay time Rise time Turn-off delay time Fall time	$V_{DD} = 50 \text{ V}, I_{D} = 12.5 \text{ A}$ $R_{G} = 4.7 \Omega V_{GS} = 5 \text{ V}$ (see <i>Figure 13</i> )	-	20 40 58 20		ns ns ns
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total gate charge Gate-source charge Gate-drain charge	$V_{DD}$ = 80 V, $I_{D}$ = 25 A, $V_{GS}$ = 5 V, $R_{G}$ = 4.7 $\Omega$ (see <i>Figure 14</i> )	-	38 8.5 21	52	nC nC nC

Table 6. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current				25	Α
I <sub>SD</sub> (1)	Source-drain current (pulsed)		-		100	Α
V <sub>SD</sub> (2)	Forward on voltage	$I_{SD} = 25 \text{ A}, V_{GS} = 0$	-		1.5	V
t <sub>rr</sub>	Reverse recovery time	$I_{SD} = 25 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$		88		ns
$Q_{rr}$	Reverse recovery charge	$V_{DD} = 50 \text{ V}, T_j = 150 ^{\circ}\text{C}$	-	317		nC
I <sub>RRM</sub>	Reverse recovery current	(see Figure 15)		7.2		Α

<sup>1.</sup> Pulse width limited by safe operating area.

<sup>2.</sup> Pulsed: pulse duration = 300  $\mu$ s, duty cycle 1.5%

Electrical characteristics STD25NF10LA

### 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

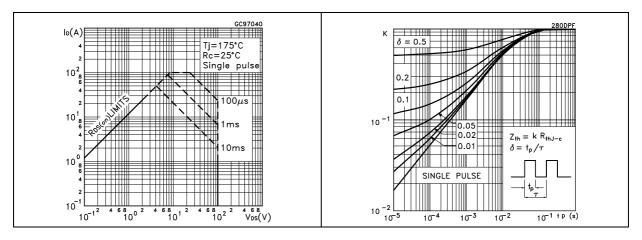


Figure 4. Output characteristics

Figure 5. Transfer characteristics

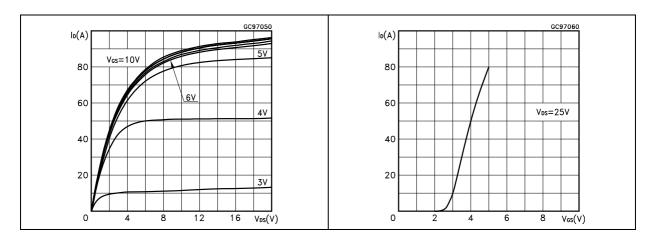


Figure 6. Normalized breakdown voltage vs. Figure 7. Static drain-source on resistance temperature

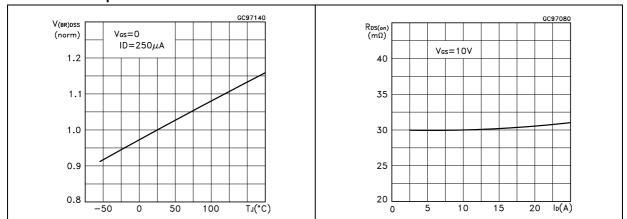


Figure 8. Gate charge vs. gate-source voltage Figure 9. Capacitance variations

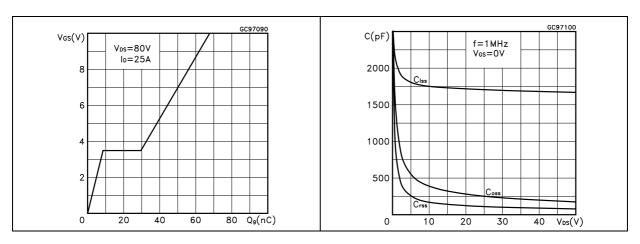


Figure 10. Normalized gate threshold voltage vs. temperature

Figure 11. Normalized on resistance vs. temperature

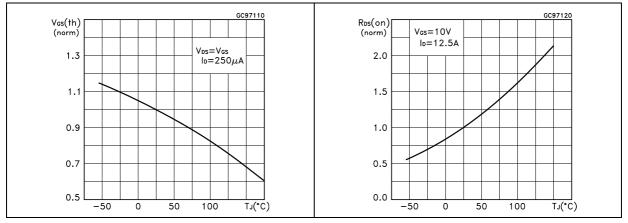
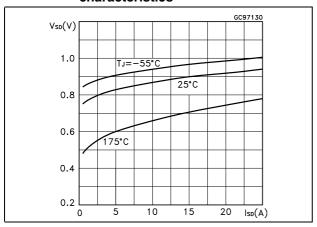


Figure 12. Source-drain diode forward characteristics



Test circuit STD25NF10LA

#### 3 Test circuit

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

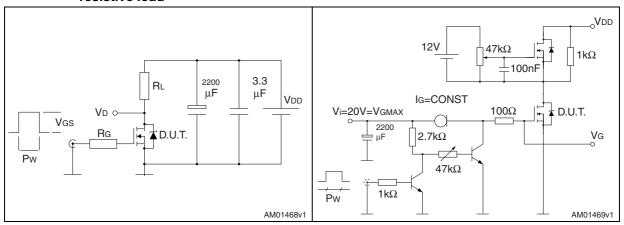


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped Inductive load test circuit

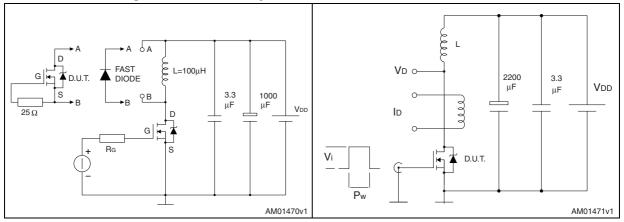
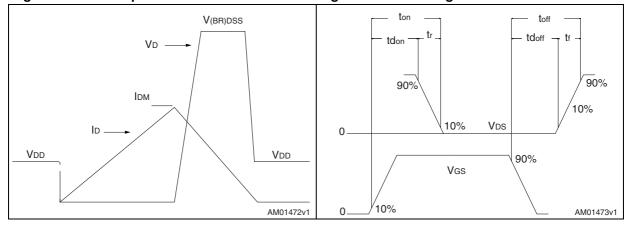


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



## 4 Package mechanical data

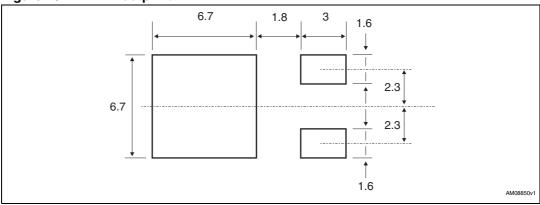
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Table 7. DPAK (TO-252) mechanical data

	Art (10 202) mediumo	mm	
Dim.	Min.	Тур.	Max.
А	2.20		2.40
A1	0.90		1.10
A2	0.03		0.23
b	0.64		0.90
b4	5.20		5.40
С	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
D1		5.10	
E	6.40		6.60
E1		4.70	
е		2.28	
e1	4.40		4.60
Н	9.35		10.10
L	1		1.50
L1		2.80	
L2		0.80	
L4	0.60		1
R		0.20	
V2	0°		8°

Figure 19. DPAK (TO-252) drawing





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a. All dimensions are in millimeters

# 5 Packing mechanical data

Table 8. DPAK (TO-252) tape and reel mechanical data

	Таре			Reel	
Dim.	m	m	Dim.	mm	
Dilli.	Min.		Dilli.	Min.	Max.
A0	6.8	7	Α		330
В0	10.4	10.6	В	1.5	
B1		12.1	С	12.8	13.2
D	1.5	1.6	D	20.2	
D1	1.5		G	16.4	18.4
Е	1.65	1.85	N	50	
F	7.4	7.6	Т		22.4
K0	2.55	2.75			
P0	3.9	4.1		Base qty.	2500
P1	7.9	8.1		Bulk qty.	2500
P2	1.9	2.1			
R	40				
Ţ	0.25	0.35			
W	15.7	16.3			

Figure 21. Tape for DPAK (TO-252)

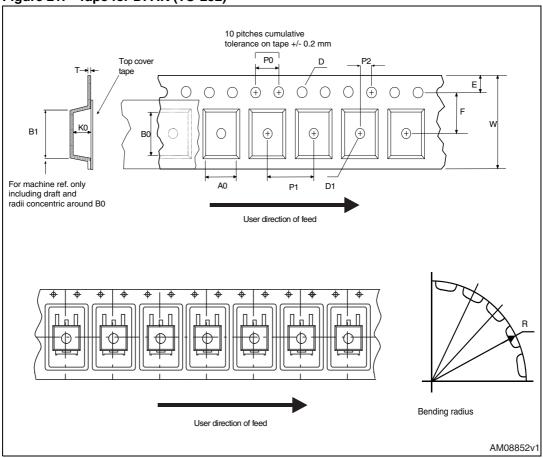
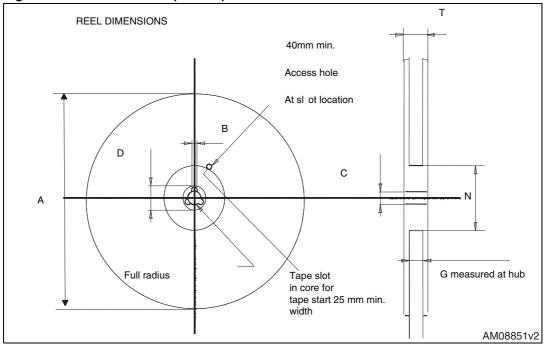


Figure 22. Reel for DPAK (TO-252)



Revision history STD25NF10LA

# 6 Revision history

Table 9. Revision history

Date	Revision	Changes
05-Oct-2011	1	First release.

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